2SK3862

Silicon N-channel junction FET

For impedance conversion in low frequency For electret capacitor microphone

■ Features

- Low noise voltage NV
- High voltage gain GV
- Thin package: TSSSMini3-F1 (1.2 mm × 1.2 mm × 0.33 mm)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Drain-source voltage (Gate open)	V _{DSO}	20	V
Drain-gate voltage (Souece open)	V_{DGO}	20	V
Drain-source current (Gate open)	I_{DSO}	2	mA
Drain-gate current (Souece open)	I_{DGO}	2	mA
Power dissipation	P_{D}	100	mW
Operating ambient temperature	Topr	-20 to +80	°C
Storage temperature	T _{stg}	-55 to +125	°C

■ Package

Code

TSSSMini3-F1

- Pin Name
 - 1: Drain
 - 2: Source
 - 3: Gate
- Marking Symbol: 5D

■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions Min Ty		Тур	Max	Unit
Drain current *1	I_D	$V_{DS} = 2.0 \text{ V}, R_d = 2.2 \text{ k}\Omega \pm 1\%$	100		470	μΑ
Drain-source current *2	I_{DSS}	$V_{DS} = 2.0 \text{ V}, R_d = 2.2 \text{ k}\Omega \pm 1\%, V_{GS} = 0$	= 0 107		460	μΑ
Forward transfer conductance	$ Y_{fs} $	$V_D = 2.0 \text{ V}, V_{GS} = 0, f = 1 \text{ kHz}$ 660 1.		1500		μS
Noise voltage *3	NV	$V_D = 2.0 \text{ V}, R_d = 2.2 \text{ k}\Omega \pm 1\%$ $C_O = 5 \text{ pF}, A\text{-curve}$			4	μV
Voltage gain	G_{V1}	$V_D = 2.0 \text{ V}, R_d = 2.2 \text{ k}\Omega \pm 1\%$ $C_O = 5 \text{ pF}, e_G = 10 \text{ mV}, f = 1 \text{ kHz}$	-5.0	-1.0		
	G_{V2}	$V_D = 12 \text{ V}, R_d = 2.2 \text{ k}\Omega \pm 1\%$ $C_O = 5 \text{ pF}, e_G = 10 \text{ mV}, f = 1 \text{ kHz}$	-3.0	3.0		
	G_{V3}	$V_D = 1.5 \text{ V}, R_d = 2.2 \text{ k}\Omega \pm 1\%$ $C_O = 5 \text{ pF}, e_G = 10 \text{ mV}, f = 1 \text{ kHz}$	-7.0	-1.5		dB
	$\Delta G_V.f ^{*4}$	$V_D = 2.0 \text{ V}, R_d = 2.2 \text{ k}\Omega \pm 1\%$ $C_O = 5 \text{ pF}, e_G = 10 \text{ mV}$ $f = 1 \text{ kHz to } 70 \text{ Hz}$	0		1.7	
Voltage gain difference	G _{V1} - G _{V3}			0.5	2.0	dB
Gate resistance	R_{g}		8	10		GΩ

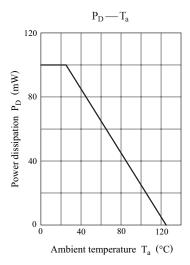
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

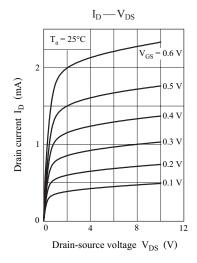
- A protection diode is built-in between gate and source of transistor. However if forward current flows between gate and source transistor might be damaged. So please be careful not insert reverse.
- 3. *1: I_D is assured for I_{DSS}
 - *2: Rank classification

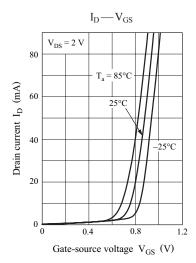
Rank	R	S	Т	U
I _{DSS} (μA)	107 to 150	130 to 220	180 to 315	285 to 460

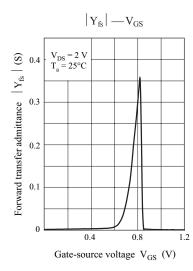
- *3: NV is assured for design.
- *4: $\Delta |G_V|$. f | is assured for AQL 0.065%. (The measurement method is used by source-grounded circuit.)

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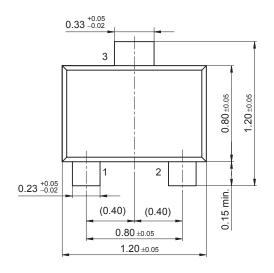


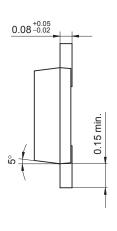
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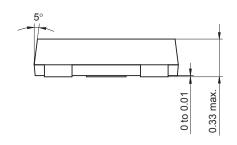
Panasonic 2SK3862

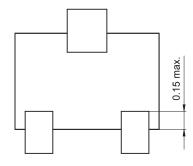
TSSSMini3-F1

Unit: mm









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